

AMENDMENTS TO THE CLAIMS:

LISTING OF CLAIMS:

1. (Previously Presented) A method of manufacturing a contactless smart card including an integrated-circuit chip and an antenna, comprising: producing metallised protrusions on two contact pads on the chip, said method including the step of connecting the chip to the antenna by embedding the metallised protrusions in a thickness of the antenna, at the time that the chip is connected to the antenna.

2. (Previously Presented) The method according to Claim 1, comprising producing the antenna from a material having a viscous state at the time that the chip is attached, to allow the embedding of the metallised protrusions.

3. (Previously Presented) The method according to claim 1, comprising producing the antenna on an insulating substrate having a form factor of the smart card.

4. (Previously Presented) The method according to claim 1, comprising producing the antenna from a thermoplastic material loaded with metallic particles and connecting the chip to the antenna by thermocompression.

5. (Previously Presented) The method according to claim 1, comprising producing the antenna from a non-polymerised conductive material and connecting the chip to the antenna by compression, and further including the step of polymerizing the antenna material by applying heat.

6. (Currently Amended) The method according to claim 1, comprising producing the antenna from a ~~moist~~ conductive polymer material in a flowable state, and connecting the chip to the antenna by compression.

7. (Previously Presented) The method according to claim 1, comprising producing the antenna from a thermoplastic material loaded with metallic particles and gluing the chip to an insulating sheet having the form factor of a smart card, and wherein the connecting of the chip to the antenna is effected by hot lamination.

8. (Previously Presented) The method according to claim 1, wherein the metallised protrusions have a substantially conical shape.